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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

Cautions

Keep safety first in your circuit designs!

1. Renesas Technology Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

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2SD768(K)

Silicon NPN Epitaxial

RENESAS

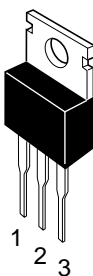
ADE-208-900 (Z)
1st. Edition
September 2000

Application

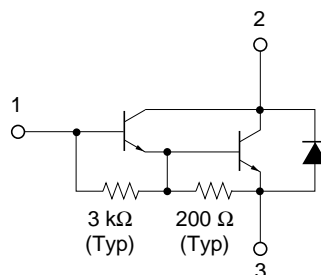
Medium speed and power switching complementary pair with 2SB727(K)

Outline

TO-220AB



1. Base
2. Collector (Flange)
3. Emitter



Absolute Maximum Ratings (T_a = 25°C)

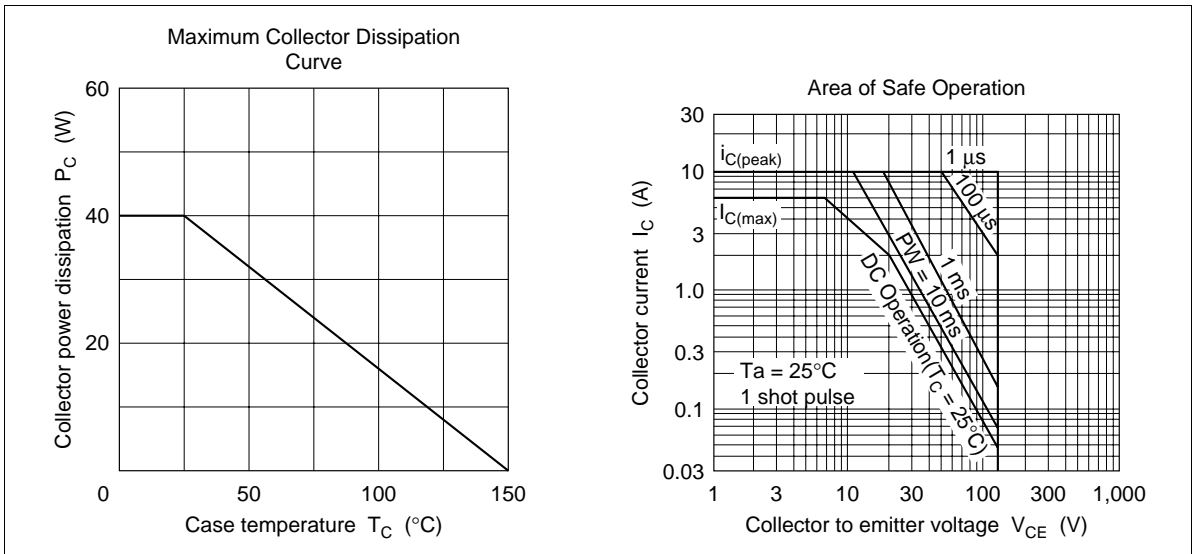
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	120	V
Collector to emitter voltage	V _{CEO}	120	V
Emitter to base voltage	V _{EBO}	7	V
Collector current	I _C	6	A
Collector peak current	I _{C(peak)}	10	A
Collector power dissipation	P _C ^{*1}	40	W
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

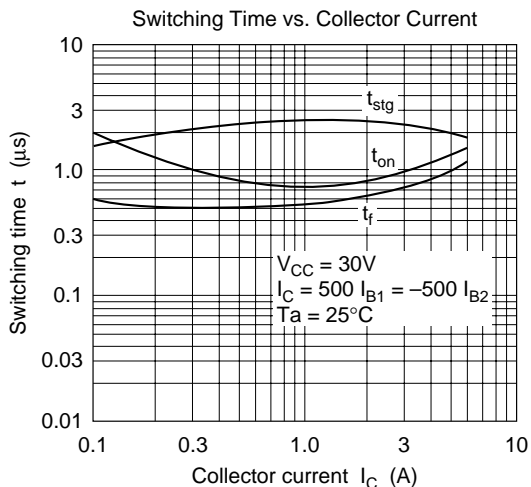
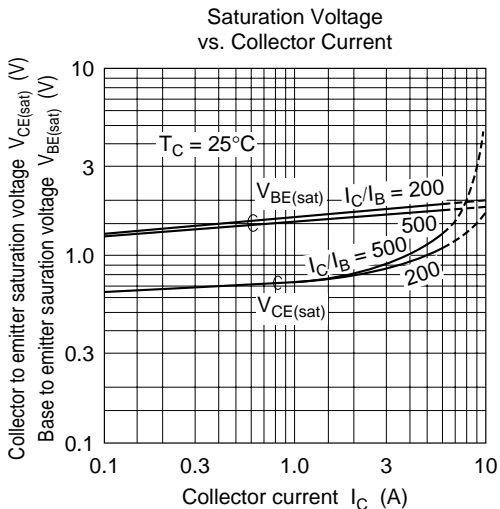
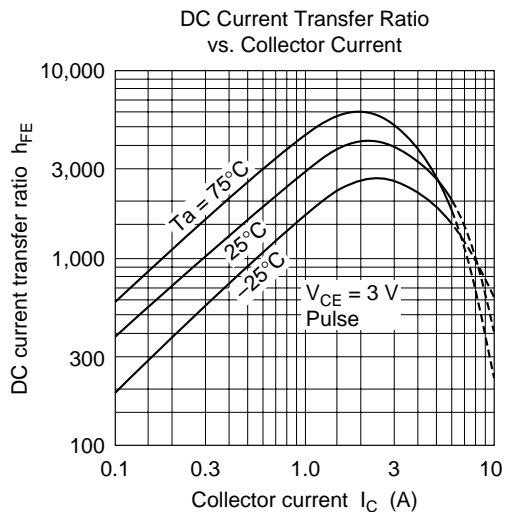
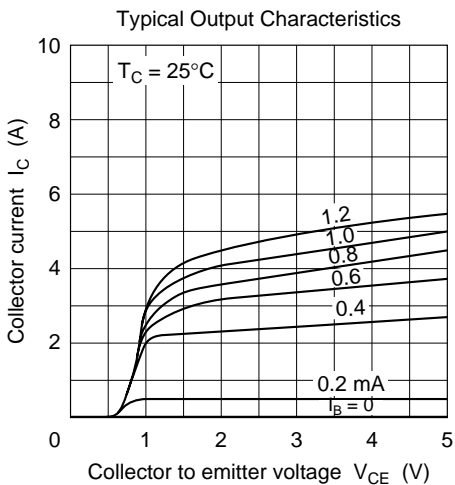
Note: 1. Value at T_c = 25°C.

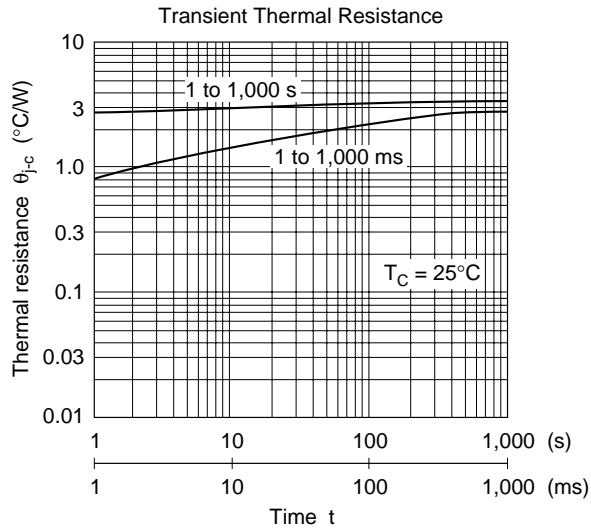
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	—	—	V	$I_C = 25 \text{ mA}$, $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	$I_E = 50 \text{ mA}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	100	μA	$V_{CB} = 120 \text{ V}$, $I_E = 0$
	I_{CEO}	—	—	10	μA	$V_{CE} = 100 \text{ V}$, $R_{BE} = \infty$
DC current transfer ratio	h_{FE}	1000	—	20000		$V_{CE} = 3 \text{ V}$, $I_C = 3 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)1}$	—	—	1.5	V	$I_C = 3 \text{ A}$, $I_B = 6 \text{ mA}^{*1}$
	$V_{CE(sat)2}$	—	—	3	V	$I_C = 6 \text{ A}$, $I_B = 60 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)1}$	—	—	2	V	$I_C = 3 \text{ A}$, $I_B = 6 \text{ mA}^{*1}$
	$V_{BE(sat)2}$	—	—	3.5	V	$I_C = 6 \text{ A}$, $I_B = 60 \text{ mA}^{*1}$
Turn on time	t_{on}	—	1.0	—	μs	$I_C = 3 \text{ A}$, $I_{B1} = -I_{B2} = 6 \text{ mA}$
Turn off time	t_{off}	—	3.0	—	μs	$I_C = 3 \text{ A}$, $I_{B1} = -I_{B2} = 6 \text{ mA}$

Note: 1. Pulse test.







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